As a below na	med inventor, I her	eby declare that:					
My residence,	post office address	and citizenship are as stated b	elow next to my name).			
I believe I am are listed below (InsertTitle)	the original, first ar w) of the subject m FIBER-REINFOR	nd sole inventor (if only ne nar atter which is claimed and for CED PLASTIC MOLDED AR	me is listed below) or a which a patent is sough ITS PROD	an original, first and joint in the invention entitled UCTION METHOD AND A	ventor (if plura MOLDING	1 names	
the specification	<u>MOLD USING TH</u>	AT METHOD			•	·	
•	_	ched hereto.					
(Check one of blocks							
1, 2, or 3.	2. was fill	ed on	No		_as		
See note A on back of	and wa	I was filed onas International PCT Application Serial No and was amended on(if applicable)					
this page)			(if applicable)				
	3. 🗆 was fil	ed on	·	· · · · · · · · · · · · · · · · · · ·	_as		
	U.S. A	ed on pplication Serial No as amended on					
	and we	anched on	(if applicable)		 •		
any amendment I acknowledge	nt referred to above the duty to disclose	and understand the contents of information which is material to					
Regulations, § I hereby claim certificate liste that of the app	1.56.	nefits under Title 35, United S	States Code. § 119 of	any foreign application(s)	for patent or in	ventor's	
	Patent	11–290907	Japan	13/10/1999	Priority	_ 2	
(List prior	(Number)		(Country)	(Day/Month/Year Filed)	O Yes	u No	
foreign	P2001-1		Japan	12/04/2001	∑ Yes	O No	
applications. See note B	(Number)		(Country)	(Day/Month/Year Filed)	☐ Yes	☐ No	
on back of	(Number)		(Country)	(Day/Month/Year Filed)	U 1es	U NO	
this page)	(Number)		(Country)	(Day/Month/Year Filed)	🖸 Yes		
(See note C or of this page)	n back	☐See attached list for add	litional prior foreign a	applications			
I hereby claim subject matter first paragraph of Federal Reg date of this app	of each of the claim of Title 35, United ulations, § 1.56 wh	Fitle 35, United States Code, § as of this application is not discled States Code, § 112, I acknowle ich occurred between the filing	120 of any United St. losed in the prior United dge the duty to disclose date of the prior appl	ates appllication(s) listed be ed States application in the n se material information as de ication and the national or P	low and, insofa nanner provide efined in Title 3 CT internation	ir as the d by the 7, Code al filing	
(List Prior U.S Applications)		(Application Serial Number)	(Filing Da	(Status) (patented,	(Status) (patented, pending, abandoned)		
		(Application Serial Number)	(Filing Da	te) (Status) (patented,	pending, abando	oned)	
Hattori, Reg. N James P.Welch 31,404; Mel R Reg. No. 30 08	lo. 32,861; John R. 1, Reg. No. 17,379; . Quintos, Reg. No. 2: Vivian P. Kafale	Attomeys James E. Armstrong, Pegan, Reg. No. 18,069; Willia Ronald F. Naughton, Reg. No. 31,898; Michael J. Foycik, Jr., nos, Reg. No.32,903; Donald W m L. Brooks, Reg. No. 34,129;	am G. Kratz, Jr., Reg. I 24,616; Albert Tockn , Reg. No. 30,928; Ma ⁷ Hanson, Reg. No. 27	No.22,631; Le-Nhung McLe nan, Reg. No. 19,722; J. Her rry E. Gormley, Reg. No. 34 .133: Stephen G. Adrian. Re	bert O'Toole, R ,409; James C. g. No. 32,878; (31,541 leg. No Lydon Gregory	
Please direct al	Il communications	M 1	ARMSTRONG, WES McLELAND & NAUC 725 K Street, N.W., S Vashington, D.C. 2000 202) 659-2930 Fax: (Suite 1000			
believed to be t punishable by t	true; and further the	s made herein of my own know at these statements were made v int, or both, under Title 18, the ication or any patent issued the	with the knowledge the United States Code,	at willful talse statements at	na ine like so m	iaue are	
(See note D on back of this page)	Full name of so	le or first inventorHide	hiko Tomokuni				
	Inventor's signa	ture Aidelileo	Tomoleuni		28/09/	<u>o/_</u>	
	Residence	Osaka, Japan	•		Date		
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Full name of second jo Inventor's signature		Shi pog	ta			28/09/01
	Ocoleo	• • •				Date
Residence						
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Post Uffice Address						
Full name of third join						
Inventor's signature	<u> </u>					Date
Residence						
Citizenship						
Post Office Address						
Full name of fourth jo	oint inventor, if any	<i>,</i>	·			
Inventor's signature						Date
Residence		<u> </u>	·			Date
Citizenship						
Post Office Address		·				
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ी ≒Full name of fifth join	tinuantar ifany					
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Full name of sixth join	nt inventor, if any					
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Inventor's signature						
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Full name of eighth jo	int inventor, if any					
Inventor's signature						
Residence						Date
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